| © Copyright 2005.                       | © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions. |                    |                           |                          | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |                         |             |           |                          |                                 |          |                  |           |
|---|--|--------------------|---------------------------|--------------------------|---|-------------------------|-------------|-----------|--------------------------|---------------------------------|----------|------------------|-----------|
|   | 1 IPC Web Site for Information on IPC-1752 Standard Fo   |                    |                           |                          | n Type * Declaration Class *<br>ribute Class 6 - RoHS Yes/No, Homogeneous Mater   |                         |             |           | ials and Mfg Information |                                 |          |                  |           |
| Supplier Information                    |  |                    |                           |                          |   |                         |             |           |                          |                                 |          |                  |           |
| Company name*                           |  | Company unique ID  |                           |                          | Unique ID Authority   |                         |             |           | Response Date*           |                                 |          |                  |           |
| onsemi                                  |  |                    |                           |                          |   |                         |             |           |                          | 2025-06-02                      |          |                  |           |
| Contact Name Title - Conta              |  |                    | Contact                   |                          |   | Phone - Contact*        |             |           |                          | Email - Contact*                |          |                  |           |
| Product-Env-Stewards Produ              |  |                    | Product Enviro Compliance |                          |   | NA                      |             |           |                          | Product-Env-Stewards@onsemi.com |          |                  |           |
| Authorized Representative* Title - R    |  |                    | tle - Representative      |                          |   | Phone - Representative* |             |           | Email - Representative*  |                                 |          |                  |           |
| Product-Env-Stewards Prod               |  |                    | Product Enviro Compliance |                          |   | NA                      |             |           |                          | Product-Env-Stewards@onsemi.com |          |                  |           |
| Requester Item Number                   | Mfr Item   | n Number           | Mfr Item Name             |                          |   | Effective Date          | Version     | N         | Manufacturing Site       |                                 | Weight*  | UOM              | Unit Type |
|   | MMBT5  | MMBT5087LT3G SS SO |                           | SS SOT23 LN XSTR PNP 50V |   | 2025-06-02              |             | C         | CN1                      |                                 | 8.02     | mg               | Each      |
| Manufacturing Proccess Inform           | ation  |                    |                           |                          |   |                         |             |           |                          |                                 |          |                  |           |
| Terminal Plating / Grid Array M         | Terminal Plating / Grid Array Material Terminal Base A   |                    | Alloy J                   | J-STD-020 MSL            | L Rating  | Peak Proc               | ess Body Te | emperatur | e Max Time at Peak       | Temperat                        | ure Numb | per of Reflow Cy | cles      |
| Matte Tin (Sn) - annealed CU Alloy      |  | CU Alloy           | 1                         | 1                        |   | 260                     |             | С         | 30                       | secon                           | ds 3     |                  |           |
| Comments                                |  |                    |                           |                          |   |                         |             |           |                          |                                 |          |                  |           |
| level 1 - maximum time at peak temperat | ture during so   | ldering is 10-3    | 0 seconds                 |                          |   |                         |             |           |                          |                                 |          |                  |           |
| For more information regarding materia  | l composition  | please refer to    | page 3                    |                          |   |                         |             |           |                          |                                 |          |                  |           |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance                    | CAS        | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|------------------------------|------------|--------|--------|-----------------|
| Die                  | 0.05   | mg              | Supplier | Silicon (Si)                 | 7440-21-3  |        | 0.05   | mg              |
| Lead Frame           | 2.92   | mg              | В        | Nickel (Ni)                  | 7440-02-0  |        | 1.06   | mg              |
|                      |        |                 | Supplier | Iron (Fe)                    | 7439-89-6  |        | 1.4658 | mg              |
|                      |        |                 | Supplier | Copper (Cu)                  | 7440-50-8  |        | 0.3942 | mg              |
| Mold Compound-Black  | 4.9    | mg              | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2 |        | 0.49   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)             | 1333-86-4  |        | 0.0245 | mg              |
|                      |        |                 | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2 |        | 0.7105 | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)          | 60676-86-0 |        | 3.185  | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)     | 9003-35-4  |        | 0.49   | mg              |
| Plating              | 0.14   | mg              | Supplier | Tin (Sn)                     | 7440-31-5  |        | 0.14   | mg              |
| Wire Bond            | 0.01   | mg              | Supplier | Palladium (Pd)               | 7440-05-3  |        | 0.0001 | mg              |
|                      |        |                 | Supplier | Copper (Cu)                  | 7440-50-8  |        | 0.0099 | mg              |